

Cray Scientific and Math Libraries

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Cray Scientific and Math Libraries (CSML)

- CSML releases a wide range of libraries useful for a variety of different scientific applications
 - Examples of scientific applications that make use of CSML libraries:
 - CP2K, LSMS, Qbox, Quantum ESPRESSO
 - Other applications in areas of computational fluid flow, multiphysics, and climate
- Include linear algebra routines for matrix operations, factorization, solvers, FFT
- Optimizations **focus on dense linear algebra routines for CPU and GPU targets**

What Do Cray Scientific Libraries Offer?

- Designed to achieve maximum performance from Cray systems with minimum effort
- **Node performance**
 - Highly tuned BLAS within nodes
- **Network performance**
 - Optimized for performance across nodes
 - Overlap between communication and computation
 - Use the best available low-level mechanism
 - Use adaptive parallel algorithms
- **Highly adaptive software**
 - Using auto-tuning and adaptation, provide the best known algorithms at runtime
- **Productivity features**
 - Simpler interfaces into complex software

Core Libraries Available Today

- Accessible by loading modules
 - cray-libsci
 - CPU targeted optimized **BLAS, LAPACK, ScaLAPACK, IRT**
 - cray-libsci_acc
 - GPU targeted optimized subset of **BLAS, LAPACK, ScaLAPACK**
 - cray-fftw
 - CPU targeted optimized **FFTW** package

Using CSML

- Current CPUs and GPUs supported include [Intel Xeon](#), [AMD EPYC](#), [Nvidia GPUs](#)
- Available today on Cray XC systems and works with
 - CCE, GNU, and Intel compilers
 - cray-mpich
- Available today on Cray CS systems and works with
 - CCE compiler
 - cray-mvapich2 and Intel MPI
- Libraries are automatically included at link time by Cray cc, CC, and ftn drivers when modulefile is loaded

Overview of `cray-libsci`

- Optimized set of BLAS, LAPACK, and ScaLAPACK libraries
 - Optimized for Intel Xeon (AVX-512) and AMD EPYC (AVX2) CPU targets
- Package includes Iterative Refinement Toolkit (IRT) set of linear solvers
 - Uses IR with mixed-precision to accelerate LU and Cholesky solvers
- Optional eigenvalue solver ScaLAPACK backends available:
 - KAUST KSVD with ZOLO-PD - optimized for large ill-conditioned inputs
 - ELPA – symmetric eigensolver (must provide path to an external self-built ELPA package)
- Cray libraries are integrated into `cray-python` and `cray-R` packages
 - NumPy and SciPy packages in `cray-python` leverage `cray-libsci` for matrix ops

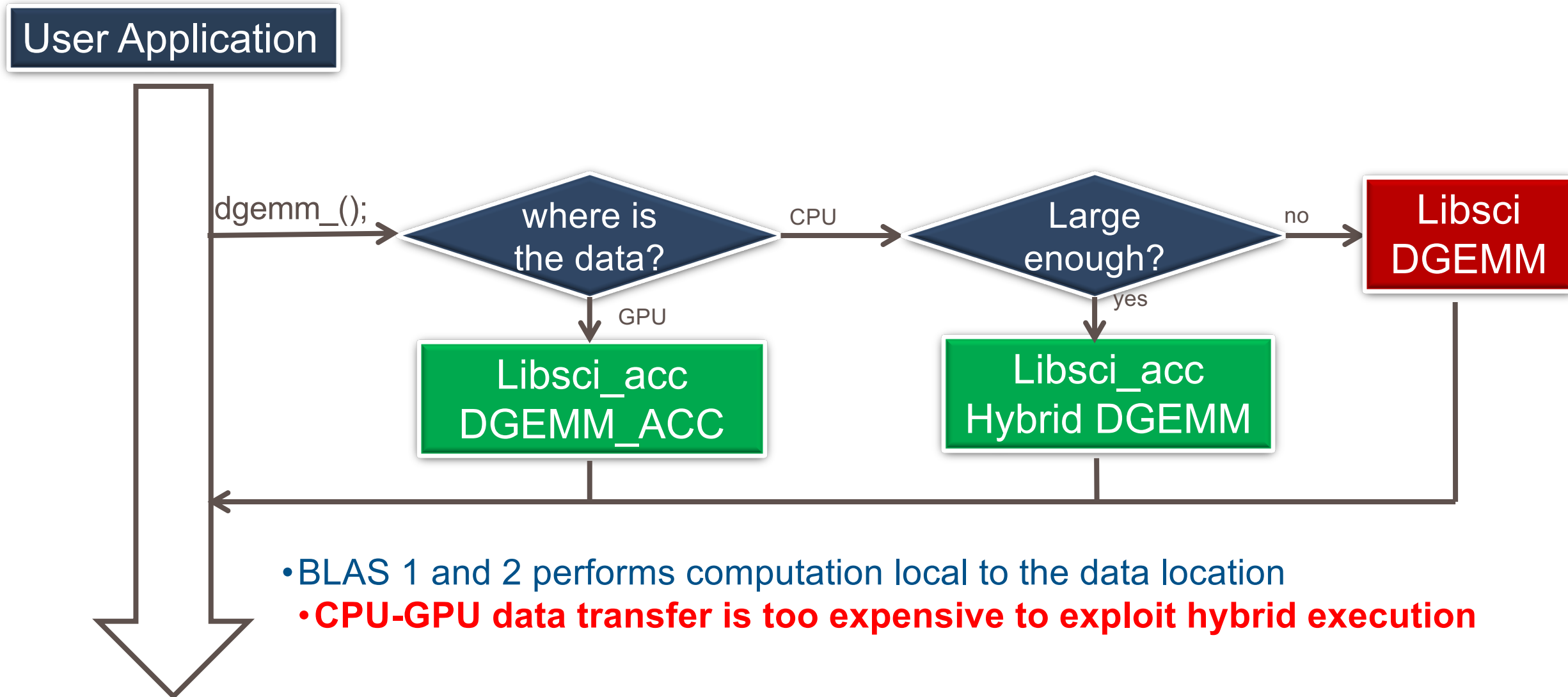
Overview of `cray-libsci_acc`

- Provides basic scientific libraries optimized for hybrid systems
 - Includes a subset of GPU optimized BLAS, LAPACK, and ScaLAPACK routines
- Independent to, but fully compatible with OpenMP
- Intended primarily as a drop-in for CPU codes to port them to GPU targets
 - For example a CPU `dgemm_(tA, tB, M, ...)` call in code would be off-loaded
- Currently support Nvidia Tesla GPGPU targets including Pascal and Volta
 - Support for AMD GPUs coming next year

Using `cray-libsci_acc`

- To use, make sure the following module is loaded:
 - `user@login> module load cray-libsci_acc`
 - Automatically loaded if GPU target module set, for example `craype-accel-nvidia60`
- Automatic and manual `cray-libsci_acc` interfaces
 - Automatic interface will detect and orchestrate CPU-GPU memory transfers
 - Includes out-of-core support (example: matrix multiple is blocked to avoid GPU memory overflow)
 - Manual interface is explicit about where memory is allocated
 - May be useful for finer control
- Currently supports OpenACC and OpenMP offload
- See [intro_libsci_acc man page](#) for more details

Automatic Interface for BLAS3 and LAPACK



Overview of cray-fftw

- Cray optimized version of the popular FFTW library
- Includes serial, threaded, and distributed (via MPI) FFTW libraries
- Supports C2C, R2C, C2R, and R2R FFTs of arbitrary size and Ndims
- Tuned for Intel Xeon (AVX-512) and AMD EPYC (AVX-2) targets
 - Includes optimized plan data for typical inputs for scientific applications
- Supports a variety of in-place and out-of-place FFT operations

Using cray-fftw

- FFTW3 libraries automatically included via Cray `cc`, `CC`, `ftn` drivers
 - `user@login> module load cray-fftw`
- Independent to, but [fully compatible with OpenMP](#)
- Uses the standard FFTW3 interfaces and API
- See [intro_fftw3 man page](#) for more details

Thank You!

QUESTIONS?

